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10-30-1998

IEET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

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To the Honorable Commissioner of Patents

Attached original documents or copy thereof.

1. Name of conveying party(ies):

Yoshinobu Hiraishi

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: October 13, 1998

2. Name and address of receiving party(ies):

Name: Komatsu Electronic Metals Co., Ltd.

Internal Address: _____

Street Address: 2612, Shinomiya, Hiratsuka-shi, Kanagawa Japan

City: _____ State: _____ ZIP: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s):

09/176173

If this document is being filed together with a new application, the execution date of the application is: October 21, 1998

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Gerald T. Shekleton, Esq.

Internal Address: _____

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41) \$40.00

- ☒ Enclosed
☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

10/26/1998 POLLEN 00000076 09176173

Street Address: WELSH & KATZ, LTD.
120 South Riverside Plaza / 22nd Floor
City: Chicago State: Illinois ZIP: 60603-3913

DO NOT USE THIS SPACE

9 Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Gerald T. Shekleton

Name of Person Signing

Signature

October 21, 1998

Date

Total number of pages including cover sheet, attachments, and document: 2

Mail documents to be recorded with required cover sheet information to:

Assistant Commissioner for Patents
Box Assignments
Washington, D.C. 20231PATENT
REEL: 9541 FRAME: 0159

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:
MECHANISM FOR CLAMPING A CRYSTAL BODY IN A CRYSTAL-BODY LIFTING

(Title of Invention)

DEVICE

for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for
 United States Letters Patent on _____, 19____ (Serial No. _____); and

WHEREAS, Komatsu Electronic Metals Co., Ltd.

(Full Name of Assignee)

a corporation of Japan

(Country of Incorporation)

whose post office address is 2612, Shinomiya, Hiratsuka-shi, Kanagawa, Japan

(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application ;

NOW THEREFORE, be it known that , for-good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/We, as assignor(s), have sold, assigned, transferred and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. FULL NAME OF SOLE OR FIRST ASSIGNOR Yoshinobu Hiraishi	ASSIGNORS SIGNATURE <i>Yoshinobu Hiraishi</i>	DATE October 13, 1998
ADDRESS c/o Komatsu Electronic Metals Co., Ltd., 2612, Shinomiya, Hiratsuka-shi, Kanagawa, Japan	CITIZENSHIP Japanese	
2. FULL NAME OF SECOND ASSIGNOR, IF ANY	ASSIGNORS SIGNATURE	DATE
ADDRESS	CITIZENSHIP	
3. FULL NAME OF THIRD ASSIGNOR, IF ANY	ASSIGNORS SIGNATURE	DATE
ADDRESS	CITIZENSHIP	
4. FULL NAME OF FOURTH ASSIGNOR, IF ANY	ASSIGNORS SIGNATURE	DATE
ADDRESS	CITIZENSHIP	
5. FULL NAME OF FIFTH ASSIGNOR, IF ANY	ASSIGNORS SIGNATURE	DATE
ADDRESS	CITIZENSHIP	
6. FULL NAME OF SIXTH ASSIGNOR, IF ANY	ASSIGNORS SIGNATURE	DATE
ADDRESS	CITIZENSHIP	